SMD Power Inductor

TMPC0518HP-Series(G)-D

		ECN HISTOR	RY LIS	Γ	
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	16/04/26	新 發 行	楊祥忠	詹偉特	何秦芝
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SMD Power Inductor

TMPC0518HP-Series(G)-D

1. Features

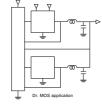
- 1. Carbonyl powder inductor.
- 2. Compact design.
- 3. High current , low DCR , high efficiency.
- 4. Very low acoustic noise and very low leakage flux noise.
- 5. High reliability.
- 6. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

Halogen-free

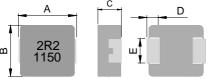


2. Applications

Note PC power system , incl. IMVP-6 DC/DC converter.

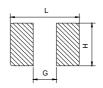


3. Dimensions



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
TMPC0518HP	5.7±0.3	5.2±0.2	1.6±0.2	1.1±0.3	2.5±0.3

Recommend PC Board Pattern



L(mm)	G(mm)	H(mm)
6.2	2.2	2.8

Note: 1. The above PCB layout reference only.
2. Recommend solder paste thickness at
0.12mm and above.

4. Part Numbering



A: Series

B: Dimension BxC

C: Type H: Carbonyl powder, P: PAD broaden

D: Inductance 2R2=2.2uH
E: Inductance Tolerance M=±20%

F: D/C 印字: 黑色, 2R2 及 D/C 1150 (D/C 前二碼是年份,後二碼是週期,依實際生產週期而定)

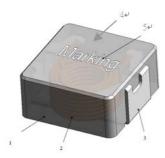
5. Specification

Part Number	Inductance L0 (uH) @ 0 A	I rms (A) typ.	l sat (A) typ.	DCR (mΩ) typ. @25℃	DCR (mΩ) max. @25℃
TMPC0518HP-R22MG-D	0.22±20%	13	22	4.2	5.0
TMPC0518HP-R33MG-D	0.33±20%	11	15	7.5	8.6
TMPC0518HP-R47MG-D	0.47±20%	10	14	9.8	11.3
TMPC0518HP-R68MG-D	0.68±20%	9	13	12.4	14.3
TMPC0518HP-1R0MG-D	1.0±20%	6.8	10	18.2	21
TMPC0518HP-1R5MG-D	1.5±20%	6.0	9.0	26	30
TMPC0518HP-2R2MG-D	2.2±20%	4.5	7.5	42	48.3
TMPC0518HP-3R3MG-D	3.3±20%	3.5	5.0	60	69
TMPC0518HP-4R7MG-D	4.7±20%	3.0	4.5	85	98
TMPC0518HP-5R6MG-D	5.6±20%	2.5	4.0	110	127
TMPC0518HP-6R8MG-D	6.8±20%	2.4	3.5	118	137
TMPC0518HP-8R2MG-D	8.2±20%	2.3	3.0	143	165
TMPC0518HP-100MG-D	10±20%	2.3	2.8	165	190

Note:

- 1. Test frequency: L: 100KHz /1.0V
- 2. All test data referenced to 25°C ambient.
- $3. \ \ \mathsf{Testing\ Instrument: L/Q: HP4284A, CH11025, CH3302, CH1320\ , CH1320\ , CH3302, CH16502, Agilent 33420A\ MICRO\ OHMMETER.}$
- 4. Heat Rated Current (Irms) will cause the coil temperature rise approximately $\,\Delta t40^\circ\!C\,$.
- 5. Saturation Current (Isat) will cause L0 to drop approximately 20%.
- 6. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- 7. Special inquiries besides the above common used types can be met on your requirement.

6. Material List



NO	Items	Materials
1	Core	Carbonyl Powder.
2	Wire	Polyester Wire or equivalent.
3	Clip	100% Pb free solder(Ni+SnPlating)
4	paint	Epoxy resin
5	lnk	Halogen-free ketone

7. Reliability and Test Condition

Item	Performance	Test Condition		
Operating temperature	-40~+125℃ (Including self - temperature rise)			
Storage temperature	110-+40℃,50-60%RH (Product without taping) 240-+125℃ (on board)			
Electrical Performance		·		
Inductance		HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.		
DCR	Refer to standard electrical characteristics list.	CH16502,Agilent33420A Micro-Ohm Meter.		
Saturation Current (Isat)	Approximately △L20%	Saturation DC Current (Isat) will cause L0 to drop △L(%)		
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise △T(°C) without core loss. 1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer		
Reliability Test				
Life Test		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 125±2°C (Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs		
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2 % R.H, Temperature: 85℃±2℃ Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs		
Moisture Resistance	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2 hrs then keep at -10°C for 3 hrs 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1–2 hrs.		
Thermal shock		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: -40±2°C 30±5min Step2: 25±2°C ≦0.5min Step3: 125±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs		
Vibration		Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations) °		

Item	Performance			Test Co	ndition	
Shock	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within±15% of initial value and shall not	Type	(g's) 50	Normal duration (D) (ms)	Half-sine	Velocity change (Vi)ft/sec 11.3
Bending	exceed the specification value	followi <0805 Bendi <0805	be mounted ing dimensions:40x100x0.8	=0805:1.2mm		11.3
Solderability	More than 95% of the terminal electrode should be covered with solder °	Solde Temp Flux fo Dip tin Depth	erature: 245 or lead free: ne: 4±1sec • : completely	Ag3% Cu0.5% $\pm 5^{\circ}$ C $^{\circ}$ Rosin. 9.5% $^{\circ}$ v cover the teri		
Resistance to Soldering Heat		Te (°0	emperature C) 0 ±5(solder mp)	Time(s)	Temperature ramp/immers and emersion 25mm/s ±6 n	n rate
Terminal Strength	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	times. Reflow With t tested (>080 tested applie gradu:	v Profiles he compone I, apply a for 5:1kg , <=(I. This force d for 60 +1 ally as not to	ce 0805:0.5kg)to shall be I seconds. Al	OClassification n a PCB with the side of so the force	reflow for 2 the device to be a device being shall be applied
			substrate		press tool	wide

Note: When there are questions concerning measurement result: measurement shall be made after 48 ± 2 hours of recovery under the standard condition.

8. Soldering and Mounting

(1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

(2) Solder re-flow:

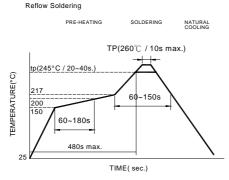
Recommended temperature profiles for re-flow soldering in Figure 1.

(3) Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

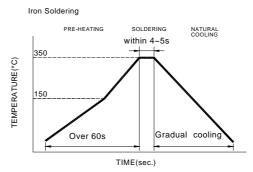
- · Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm

- 355°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.



Reflow times: 3 times max.

Fig.1

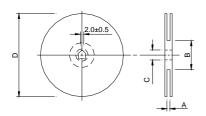


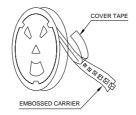
Iron Soldering times: 1 times max.

Fig.2

9. Packaging Information

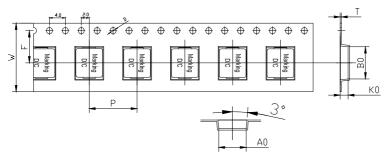
(1) Reel Dimension





Туре	A(mm)	B(mm)	C(mm)	D(mm)
13"x12mm	12.4+2/-0	100±2	13+0.5/-0.2	330

(2) Tape Dimension

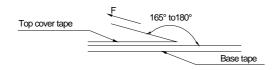


Serie	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)
TMPC	0518	6.2±0.1	5.6±0.1	2.1±0.1	8.0±0.1	12.0±0.3	5.5±0.1	0.35±0.05	1.5±0.1

(3) Packaging Quantity

ТМРС	0518
Chip / Reel	3000
Inner box	6000
Carton	24000

(4) Tearing Off Force



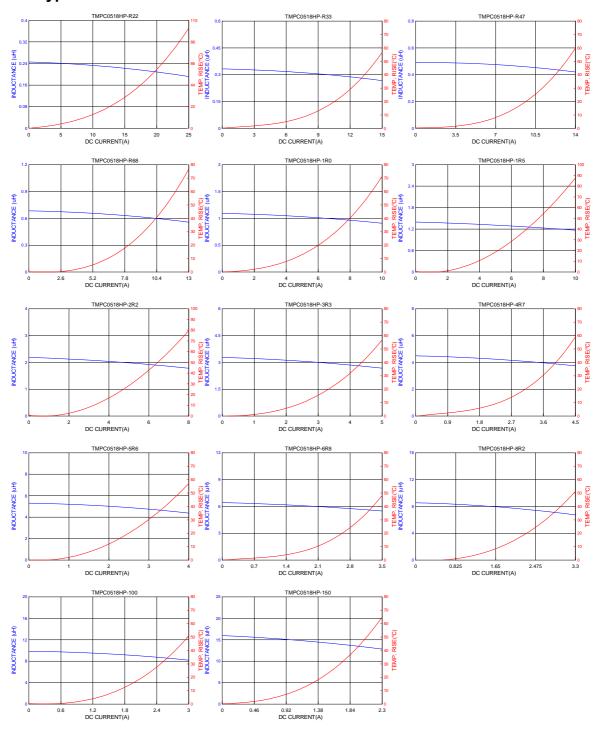
The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-C-2003 of 4.11 standard).

Room Temp.	Room Humidity	Room atm	Tearing Speed
(℃)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions (component level)
- To maintain the solderability of terminal electrodes:
- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40°C and 60% RH.
- 3. Recommended products should be used within 12 months form the time of delivery.
- ${\bf 4. \ The \ packaging \ material \ should \ be \ kept \ where \ no \ chlorine \ or \ sulfur \ exists \ in \ the \ air.}$
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

10. Typical Performance Curves





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(耀錯科技股份有限公司 / YOSONIC TECHNOLOGY CO., LTD.)

(慶邦電子元器件(泗洪)有限公司 / TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as):

樣品名稱(Sample Description)

SMD POWER INDUCTOR

樣品型號(Style/Item No.)

TMPB · TMPC · TMPA · TMPF · SLPI · SMPI · SMPI-P3 · EPI(ePI) · VMPI · MLPI

收件日期(Sample Receiving Date)

2015/10/02

測試期間(Testing Period)

2015/10/02 TO 2015/10/12

測試結果(Test Results)

請見下一頁 (Please refer to next pages).



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Test Report

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測試結果(Test Results)

測試部位(PART NAME)No.1

: 整體混測 (MIXED ALL PARTS)

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限值 (MDL)	結果 (Result) No.1
鎬 / Cadmium (Cd)	mg/kg	參考IEC 62321-5: 2013方法, 以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-5: 2013 and performed by ICP-AES.	2	n. d.
鉛 / Lead (Pb)	mg/kg	参考IEC 62321-5: 2013方法,以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-5: 2013 and performed by ICP-AES.	2	n. d.
汞 / Mercury (Hg)	mg/kg	参考IEC 62321-4: 2013方法,以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-4: 2013 and performed by ICP-AES.	2	n. d.
六價络 / Hexavalent Chromium Cr(VI)	mg/kg	参考IEC 62321: 2008方法,以UV-VIS 檢測. / With reference to IEC 62321: 2008 and performed by UV- VIS.	2	n. d.
绨 / Antimony (Sb)	mg/kg	參考US EPA 3052方法,以感應耦合電 漿原子發射光譜儀檢測. / With reference to US EPA Method 3052. Analysis was performed by ICP-AES.	2 .	n. d.

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鄭苯二甲酸丁苯甲酯 / BBP (Butyl Benzyl phthalate) (CAS No.: 85-68-7)	mg/kg		50	n. d.
鄰苯二甲酸二丁酯 / DBP (Dibutyl phthalate) (CAS No.: 84-74-2)	mg/kg		50	n. d.
鄰苯二甲酸二 (2-乙基己基)酯 / DEHP (Di- (2-ethylhexyl) phthalate) (CAS No.: 117-81-7)	mg/kg	參考IEC 62321-8 (111/321/CD),以氣相層析儀/質譜儀檢測之. / With reference to IEC 62321-8 (111/321/CD). Analysis was performed by GC/MS.	50	n. d.
鄰苯二甲酸二異丁酯 / DIBP (Di- isobutyl phthalate) (CAS No.: 84-69- 5)	mg/kg		50	n. d.
鄰苯二甲酸二異癸酯 / DIDP (Di- isodecyl phthalate) (CAS No.: 26761- 40-0; 68515-49-1)	mg/kg		50	n. d.
鄰苯二甲酸二異壬酯 / DINP (Di- isononyl phthalate) (CAS No.: 28553- 12-0; 68515-48-0)	mg/kg		50	n. d.
鄰苯二甲酸二正辛酯 / DNOP (Di-n-octyl phthalate) (CAS No.: 117-84-0)	mg/kg		50	n. d.

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測試項目 (Togt Itang)	單位 (Unit)	測試方法 (Method)	方法偵測 極限值	結果 (Result)
(Test Items)	(Unit)	(method)	(MDL)	No. 1
多溴聯苯總和 / Sum of PBBs	mg/kg			n. d.
一溴聯苯 / Monobromobiphenyl	mg/kg		5	n. d.
二溴聯苯 / Dibromobiphenyl	mg/kg		5	n. d.
三溴聯苯 / Tribromobiphenyl	mg/kg		5	n. d.
四溴聯苯 / Tetrabromobiphenyl	mg/kg]	5	n. d.
五溴聯苯 / Pentabromobiphenyl	mg/kg		5	n, d.
六溴聯苯 / Hexabromobiphenyl	mg/kg		5	n. d.
七溴聯苯 / Heptabromobiphenyl	mg/kg	參考IEC 62321-6: 2015方法,以氣相 層析/質譜儀檢測. / With reference to IEC 62321-6: 2015 and performed	5	n, d,
八溴聯苯 / Octabromobiphenyl	mg/kg		5	n. d.
九溴聯苯 / Nonabromobiphenyl	mg/kg		5	n. d.
十溴聯苯 / Decabromobiphenyl	mg/kg		5	n. d.
多溴聯苯醚總和 / Sum of PBDEs	mg/kg		<u></u>	n. d.
一溴聯苯醚 / Monobromodiphenyl ether	mg/kg	by GC/MS.	5	n. d.
二溴聯苯醚 / Dibromodiphenyl ether	mg/kg		5	n. d.
三溴聯苯醚 / Tribromodiphenyl ether	mg/kg		- 5	n. d.
四溴聯苯醚 / Tetrabromodiphenyl ether	mg/kg		5	n. d.
五溴聯苯醚 / Pentabromodiphenyl ether	mg/kg		5	n, d.
六溴聯苯醚 / Hexabromodiphenyl ether	mg/kg		5	n. d.
七溴聯苯醚 / Heptabromodiphenyl ether	mg/kg		5	n. d.
八溴聯苯醚 / Octabromodiphenyl ether	mg/kg		5	n. d.
九溴聯苯醚 / Nonabromodiphenyl ether	mg/kg		5	n. d.
十溴聯苯醚 / Decabromodiphenyl ether	mg/kg		5	n. d.

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Test Report

西北臺慶科技股份有限公司 /TAI-TECH ADVANCED ELECTRONICS CO., LTD.

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(耀鑽科技股份有限公司 / YOSONIC TECHNOLOGY CO., LTD.)

(慶邦電子元器件(泗洪)有限公司 / TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

桃園市橘梅區幼獅工業區幼四路1號 / NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN, R. O. C.

(江蘇省昆山市壅朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

(桃園市中堰區中堰工業區長春六路15號 / NO. 15, CHANGCHUN 6TH RD., JHONGLI CITY, TAOYUAN COUNTY 320, TAIWAN)

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. 測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
六溴環十二烷及所有主要被辨別出的異構物 / Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α - HBCDD, β - HBCDD, γ - HBCDD) (CAS No.: 25637-99-4 and 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	mg/kg	参考IEC 62321: 2008方法,以氣相層析/質譜儀檢測. / With reference to IEC 62321: 2008 method. Analysis was performed by GC/MS.	5	n. d.
鹵素 / Halogen				
鹵素(氟)/ Halogen-Fluorine (F) (CAS No.: 14762-94-8)	mg/kg	参考BS EN 14582:2007,以離子層析儀 分析. / With reference to BS EN 14582:2007. Analysis was performed by IC.	50	n. d.
鹵素(氣)/ Halogen-Chlorine (C1) (CAS No.: 22537-15-1)	mg/kg		50	n, d.
鹵素(溴)/ Halogen-Bromine (Br) (CAS No.: 10097-32-2)	mg/kg		50	n. d.
鹵素(碘)/ Halogen-Iodine(I)(CAS No.: 14362-44-8)	mg/kg		50	n. d.

備註(Note):

- 1. mg/kg = ppm : 0.1wt% = 1000ppm
- 2. n.d. = Not Detected (未檢出)
- 3. MDL = Method Detection Limit (方法偵測極限值)
- 4. "-" = Not Regulated (無規格值)
- 5. 樣品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個別單一材質的含量. (The samples was/were analyzed on behalf of the applicant as mixing sample in one testing. The above results was/were only given as the informality value.)

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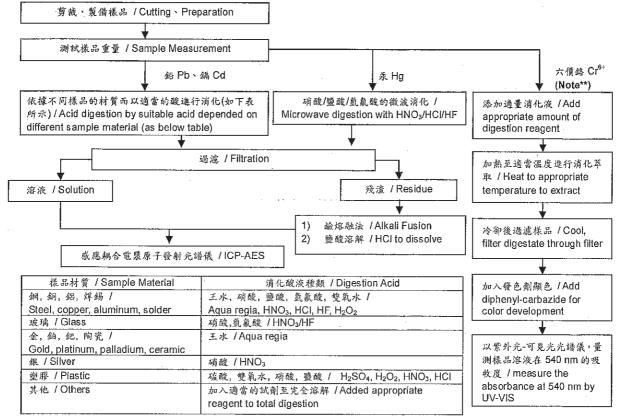
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- 1) 根據以下的流程圖之條件,樣品已完全溶解。(六價鉻測試方法除外) / These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cr6* test method excluded)
- 測試人員:楊登偉 / Name of the person who made measurement: Climbgreat Yang
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang



Note** (For IEC 62321)

- (1) 針對非金屬材料加入鹼性消化液,加熱至 90~95℃ 萃取. / For non-metallic material, add alkaline digestion reagent and heat to 90~95°C
- (2) 針對金屬材料加入純水,加熱至沸騰萃取. / For metallic material, add pure water and heat to boiling.

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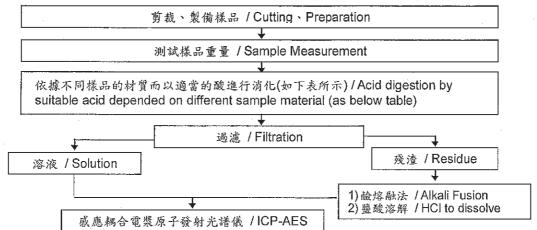
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- 根據以下的流程圖之條件,樣品已完全溶解。 / These samples were dissolved totally by pre-conditioning method according to below flow chart.
- 測試人員:楊登偉 / Name of the person who made measurement: Climbgreat Yang
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang

元素以 ICP-AES 分析的消化流程圖 (Flow Chart of digestion for the elements analysis performed by ICP-AES)



鋼,銅,鋁,焊錫 / Steel, copper, aluminum, solder	王水,硝酸,鹽酸,氫氟酸,雙氧水 / Aqua regia, HNO ₃ , HCI, HF, H ₂ O ₂
玻璃 / Glass	硝酸,氫氟酸 / HNO ₃ /HF
金,鉑,鉅,陶瓷 / Gold, platinum, palladium, ceramic	王水 / Aqua regia
銀 / Silver	硝酸 / HNO ₃
塑膠 / Plastic	硫酸,雙氧水,硝酸,鹽酸 / H ₂ SO ₄ , H ₂ O ₂ , HNO ₃ , HCI -
其他 / Others	加入適當的試劑至完全溶解 / Added appropriate reagent to total digestion

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多溴聯苯/多溴聯苯醚分析流程圖 / PBB/PBDE analytical FLOW CHART

- 測試人員: 翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang

初次測試程序 / First testing process -

選擇性篩檢程序 / Optional screen process •• 確認程序 / Confirmation process - · → ·

> Sample / 樣品 Sample pretreatment / 樣品前處理 Screen analysis / 初篩分析 Sample extraction 樣品萃取/ Soxhlet method 索式萃取法 Concentrate/Dilute Extracted solution 萃取液濃縮/稀釋 Filter / 萃取液過濾 Analysis by GC/MS / 氣相層析質譜儀分析

> > Issue Report 撰打報告

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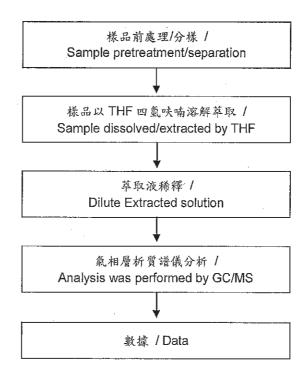
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可塑劑分析流程圖 / Analytical flow chart of phthalate content

- 測試人員:徐毓明 / Name of the person who made measurement: Andy Shu
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang

【測試方法/Test method: IEC 62321-8】



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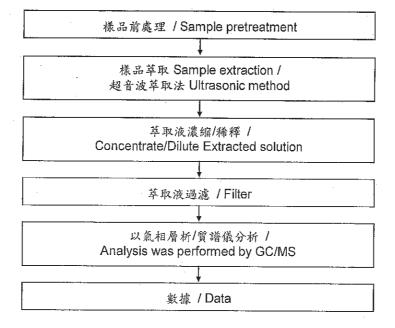
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六溴環十二烷分析流程圖 / HBCDD analytical flow chart

- 測試人員:翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang



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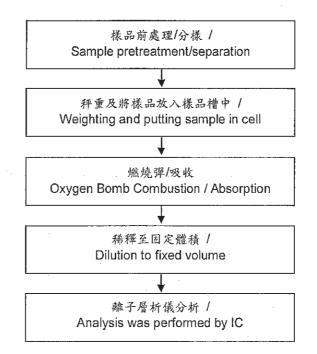
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鹵素分析流程圖 / Analytical flow chart of halogen content

- 測試人員: 陳思臻 / Name of the person who made measurement: Rita Chen
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang



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Test Report

號碼(No.): CE/2015/A0547

日期(Date): 2015/10/12

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西北臺慶科技股份有限公司 /TAI-TECH ADVANCED ELECTRONICS CO., LTD.

(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

(耀鑽科技股份有限公司 / YOSONIC TECHNOLOGY CO., LTD.)

(慶邦電子元器件(泗洪)有限公司 / TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

桃園市楊梅區幼獅工業區幼四路1號 / NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN, R. O. C.

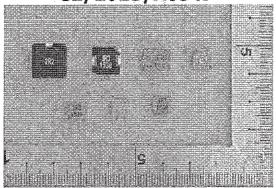
(江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHIMA)

(桃園市中堰區中堰工業區長春六路15號 / NO. 15, CHANGCHUN 6TH RD., JHONGLI CITY, TAOYUAN COUNTY 320, TAIWAN)

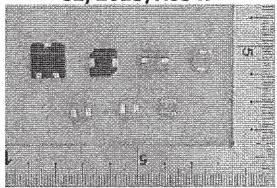
(江蘇省宿遷市泗洪縣經濟開發區金沙南路-高新技術產業園(HIGH-TECH INDUSTRIAL DISTRICT, JINSHAJIANG ROAD, SIHONG COUNTY ECONOMIC, SUQIAN CITY, JIANGSU)

> * 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. * (The tested sample / part is marked by an arrow if it's shown on the photo.)

> > CE/2015/A0547



CE/2015/A0547



** 報告結尾 (End of Report) **

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